

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"5935455".pn. or "6628084".pn.	US-PGPUB; USPAT	OR	ON	2005/03/21 10:05
L2	1	"6126776".pn.	US-PGPUB; USPAT	OR	ON	2005/03/21 10:07
L3	9	"9800457"	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 10:08
L4	4	((("N.K.T. Research").as. or ("NKT research").as. or Jensen.in. or Glejbol.in.) and (metalliz\$6 near5 polymer)	US-PGPUB; USPAT	OR	ON	2005/03/21 10:22
L5	3	((("N.K.T. Research").as. or ("NKT research").as. or Jensen.in. or Glejbol.in.) and (plasma near2 polymeri\$7) and ((deposit\$3 or \$4CVD or PVD or sputter\$4) near3 metal\$5)	US-PGPUB; USPAT	OR	ON	2005/03/21 10:22
L6	1	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and (plasma near2 polymeri\$7) and ((deposit\$3 or \$4CVD or PVD or sputter\$4) near3 metal\$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 10:23
L7	17	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and (metalliz\$6 near5 polymer)	US-PGPUB; USPAT	OR	ON	2005/03/21 10:24
L8	1	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and (metalliz\$6 near5 polymer)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 10:25
L9	4	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and ((pretreat\$4 or preclean\$4 or (pre adj (treat\$4 or clean\$4)) or radical) with plasma) and (plasma with (graft\$4 or polymeriz\$8 or monomer\$3))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 10:27
L10	26	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and ((pretreat\$4 or preclean\$4 or (pre adj (treat\$4 or clean\$4)) or radical) with plasma) and (plasma with (graft\$4 or polymeriz\$8 or monomer\$3))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:27

L11	6	L10 and ((coat\$4 or film or deposit\$5 or layer or electroless\$4 or electrolytic\$4 or plate or plated or plating or pvd or \$4cvd) with (metal\$4 or Cu or copper or Ag or silver or Pt or platinum or Pd or palladium or Sn or tin or Au or gold))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:33
L12	20	L10 not L11	US-PGPUB; USPAT	OR	ON	2005/03/21 10:33
L13	411	(427/488,491).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:34
L14	1450	(427/533,534,535,536,537).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:34
L15	3415	(427/250,255.6,255.7).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:34
L16	1323	(427/304,305).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:35
L17	773	(427/306).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:35
L18	1187	(427/437,443.1).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:35
L19	180	(204/192.14).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:35
L20	158	(205/158,165).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:35
L21	276	(205/205).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:35
L22	6799	((427/488,491).CCLS.) ((427/533,534,535,536,537).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/03/21 10:35
L23	4	((427/537).CCLS.) and ((427/306).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/03/21 10:36

L24	1	((427/488,491).CCLS.) and (((427/533,534,535,536).CCLS.) or ((427/537).CCLS.)) and (((427/304, 305).CCLS.) or ((427/306).CCLS.) or ((427/437,443.1).CCLS.) or ((205/158,165).CCLS.) or ((205/205).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:37
L26	1	((427/488,491).CCLS.) and (((427/304,305).CCLS.) or ((427/306).CCLS.) or ((427/437, 443.1).CCLS.) or ((205/158,165). CCLS.) or ((205/205).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:37
L27	116	(427/537).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/21 10:37
L29	94	((427/488,491).CCLS.) and (((427/533,534,535,536).CCLS.) or ((427/537).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:40
L30	18	((427/488,491).CCLS.) and (electroplat\$5 or (electroless) or (electro adj less))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:42
L31	6	(((427/488,491).CCLS.) ((427/533, 534,535,536).CCLS.) ((427/537). CCLS.) ((427/250,255.6,255.7). CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443. 1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205). CCLS.)) and (metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 10:45

L32	292	L22 and ((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) and ((plasma or (glow adj discharge)) with (polymeri\$7 or monomer\$3)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or deposit\$4 or coat\$4 or film or layer or electroless\$4 or electroly\$6) with (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:15
L33	133	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) and ((plasma or (glow adj discharge)) with (polymeri\$7 or monomer\$3)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or deposit\$4 or coat\$4 or film or layer or electroless\$4 or electroly\$6) with (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:07
L34	1278	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) and ((plasma or (glow adj discharge)) near4 (polymeri\$7 or monomer\$3)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or deposit\$4 or coat\$4 or film or layer or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:17

L35	370	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) and ((plasma or (glow adj discharge)) near4 (polymeri\$7 or monomer\$3) with (coat\$4 or deposit\$4 or film or layer)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:23
L36	307	L35 not L32	US-PGPUB; USPAT	OR	ON	2005/03/21 11:18
L37	11	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) same ((plasma or (glow adj discharge)) near4 (polymeri\$7 or monomer\$3) with (coat\$4 or deposit\$4 or film or layer)) same ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:20
L38	11	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and (((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) same ((plasma or (glow adj discharge)) near4 (polymeri\$7 or monomer\$3) with (coat\$4 or deposit\$4 or film or layer)) same ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:22

L39	6	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and (((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) same ((plasma or (glow adj discharge)) near4 (polymeriz\$7 or monomer\$3) with (coat\$4 or deposit\$4 or film or layer)) same ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:22
L40	311	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) and ((plasma or (glow adj discharge)) near4 (polymeriz\$7 or monomer\$3) with (coat\$4 or deposit\$4 or film or layer)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:24
L41	257	L40 not L32	US-PGPUB; USPAT	OR	ON	2005/03/21 11:23
L42	7	((metalliz\$6 or substrate or base or sheet or film or substratum) near5 (polymer\$2 or organic or resin)) and ((plasma or (glow adj discharge)) with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or preclean\$4)) and ((plasma or (glow adj discharge)) near4 (polymeriz\$7 or monomer\$3) with (coat\$4 or deposit\$4 or film or layer)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3 or electroless\$4 or electroly\$6) near4 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:24

L43	37	((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) and (((427/488, 491).CCLS.) ((427/533,534,535, 536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306). CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158, 165).CCLS.) ((205/205).CCLS.)))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:33
L44	231	((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) not (((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) and (((427/488,491). CCLS.) ((427/533,534,535,536). CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306). CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158, 165).CCLS.) ((205/205).CCLS.)))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:34
L45	87	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5)	US-PGPUB; USPAT	OR	ON	2005/03/21 11:34

L46	1	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:35
L47	1	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:35
L48	5	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:35
L49	10	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:35



L50	27	((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.)) and (metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or polymeriz\$7)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	US-PGPUB; USPAT	OR	ON	2005/03/21 11:36
L51	142	(metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or polymeriz\$7)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$5 or (electrolytic\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:47
L52	1	"6214422".pn. and (\$9cyanoacrylate or (\$9cyano adj \$4acrylate) or cyanomethacrylate or (acrylic adj acid) or (triethylene adj glycol adj diacrylate) or (glycidyl adj \$4acrylate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:51
L53	0	"6214422".pn. and ((glycidyl))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:52
L54	0	"6214422".pn. and ((glycidyl\$10))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:52
L55	0	"6214422".pn. and ((glycidyl\$15))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:56

L56	15	\$10acrylate same (allylene or allylalcohol or allyloxymethylsilane or allylphenol or allylurea or allylthiourea) same ((vinyl adj acetic adj acid) or (vinyl adj norbornene) or (vinyl adj pyrrolidone) or (vinyl adj trimethoxysilane) or (vinyl adj trimethylsilane))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/21 11:59
-----	----	--	---	----	----	------------------